

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT2789594

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	JAE CHAN KIM	03/27/2014
	DOO HWAN OH	03/27/2014
	KWANG SIC JOO	03/27/2014
	YEOUN SOOK CHUN	03/27/2014
	SUNG WOOK WEE	03/27/2014
	KYOUNG WOO KIM	03/27/2014
RECEIVING PARTY DATA		
Name:	CHUNG-ANG UNIVERSITY INDUSTRY-ACADEMIC COOPERATION FOUNDATION	
Street Address:	221 HEUKSEOK-DONG, DONGJAK-GU	
City:	SEOUL	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	156-756	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	14348051
CORRESPONDENCE DATA		
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ATTORNEY DOCKET NUMBER:	2280-026	
NAME OF SUBMITTER:	HYUN YONG LEE	
SIGNATURE:	/Hyun Yong Lee/	
DATE SIGNED:	03/28/2014	
Total Attachments: 2		

PATENT

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ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we the undersigned, **KIM, Jae Chan; OH, Doo Hwan; JOO, Kwang Sic; CHUN, Yeoun Sook; WEE, Sung Wook and KIM, Kyoung Woo**, hereby sell, assign, and transfer **CHUNG-ANG UNIVERSITY INDUSTRY-ACADEMIC COOPERATION FOUNDATION**, a corporation of Republic of Korea, having a principal place of businesses at **221 Heukseok-dong, Dongjak-gu, Seoul 156-756, Republic of Korea** ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements that are disclosed in the application for the United States patent, entitled:

NOVEL USE OF ANGIOGENIN

- ☒ which has been executed by the undersigned concurrently herewith,
☐ which was filed on _____ and assigned _____

and in to said application and all divisional, continuing, substitute, renewal, reissue, and all other patent applications that have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application;

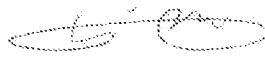
agree that said Assignees may apply for and receive a patent or patents for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignees, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all assignments and powers of attorney; communicate to said Assignees, its successors, assigns, and representatives all facts known to the undersigned relating to said improvements and the history thereof; and generally assist said Assignees, its successors, assigns, or representatives in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements, and all applications for patents and all patents on said improvements, in said Assignees, its successors, assigns, and legal representatives; and

covenant with said Assignees, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Attorney Docket No.: 2280-026
Client Docket No.: AOP-2014-0024/US

Each Inventor: Please Sign and Date Below:

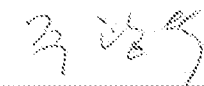
03-27, 2014
Date


Name: KIM, Jae Chan

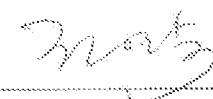
03-27, 2014
Date


Name: OH, Doo Hwan

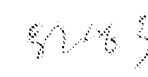
03-27, 2014
Date


Name: JOO, Kwang Sic

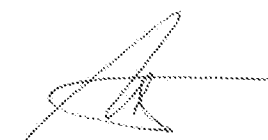
03-27, 2014
Date


Name: CHUN, Yeoun Sook

03-27, 2014
Date


Name: WEE, Sung Wook

03-27, 2014
Date


Name: KIM, Kyoung Woo